

Design and Analysis of CMOS Based Temperature Sensor and Its Readout Circuit

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ABSTRACT

In this paper, the proposed sensor utilizes the temperature dependency of MOSFET and BJT for designing of this sensor. The voltage or current across MOSFETs and BJT always varies with the temperature, but the challenge in this project is to design these types of sensors to linearize this variation. This task is accomplished by proper selection of circuit architecture by adjusting W/L Ratio of the transistors and choosing the proper resistor value so that the non-linearity can be reduced. After achieving the linearity, readout circuit is designed for to digitize the obtained temperature information. The proposed temperature sensor is simulated in Cadence Analog Design Environment with GPDK180nm library.

I. INTRODUCTION

Temperature is one of the most important fundamental physical quantity and is almost common in our daily life and which is independent of the amount of material i.e. temperature is having intensive property. As we know hundreds or thousands of devices are formed on thin silicon wafers[2]. Before the wafer is scribed and cut into individual chips, they are usually laser trimmed. Temperature is a physical quantity that is a measure of hotness and coldness on a numerical scale. In a body in its own internal thermal equilibrium, the temperature is spatially uniform. Temperature is important in all fields of natural science. One popular use of temperature sensors in VLSI implementation is in the emergence of RFID and wireless sensor network (WSN) applications.

With microprocessors scaling to higher performance and faster speed, heat dissipation has become a growing concern. Excessive heat degrades performance and increases power consumption of the entire system. Safe operation of the integrated circuits requires the prevention of excessive chip temperatures.

To prevent overheating, multiple integrated temperature sensors are employed in the microprocessor to monitor its thermal distribution.

II. PROPOSED SCHEME

In this paper, proposed sensor investigates two cases. In the first case, temperature sensor is designed by utilizing temperature dependency characteristics of BJT and MOSFET in Saturation region and in the second case, temperature sensor is designed by utilizing temperature dependency characteristics of only MOSFET in Sub threshold region.

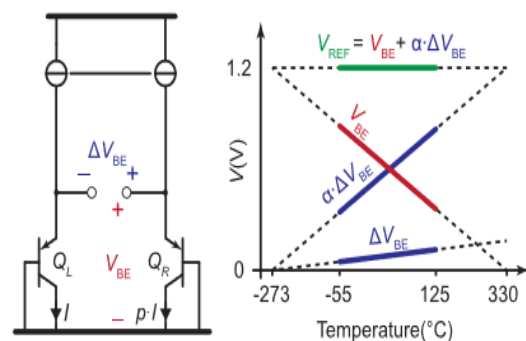


Figure 1. Basic operation of PTAT and CTAT curve.

The main aim of this project is to design a circuit to obtain Proportional to absolute temperature value (PTAT). To obtain this PTAT voltage, necessary design conditions has been considered. Basic operation of a PNP based circuit showing PTAT and CTAT behaviour is as shown in figure 1.

$$V_T = KT/q \dots \dots \dots (1)$$

Where,

V_T denotes thermal voltage.

T denotes temperature.

Q denotes electric charge.

K denotes proportionality constant.

From equation (1), it is clear that the V_T is directly proportional to temperature.

Voltage across BJT is given by equation (2)

$$V_{BE} = V_T \ln (I/I_s) \dots \dots \dots (2)$$

$$I = I_s e^{V_{BE}/V_T} \dots \dots \dots (3)$$

Where,

V_{BE} denotes base to emitter voltage.

I denotes the current flowing through each transistor.

I_s denotes reverse saturation current.

Equation (2) shows CTAT behaviour because of I_s term.

When 'n' number of transistors are considered, equation becomes as shown in (4)

$$V_{BE1} = V_T \ln (I/n I_s) \dots \dots \dots (4)$$

$$\Delta V_{BE} = V_{BE} - V_{BE1} \dots \dots \dots (5)$$

$$\Delta V_{BE} = V_T \ln (n) \dots \dots \dots (6)$$

Where,

'n' denotes number of transistors.

ΔV_{BE} denotes difference between base to emitter voltage .

In equation (6), ΔV_{BE} represents PTAT voltage since it is equal to V_T because $\ln(n)$ is constant.

In equation (2), term (I/I_s) represents complementary to absolute temperature since I_s depends upon

temperature. In this work, the main concentration is on obtaining Thermal voltage because it is PTAT, so it is necessary to cancel the CTAT term.

To cancel the CTAT term, the necessary circuits have been designed by employing a technique which connects pnp transistors in parallel and so that voltages across them are same. The difference between the base to emitter voltages have been taken into consideration, which gives the required PTAT value.

A. Temperature dependency characteristics of BJT and MOSFET in Saturation region

In this proposed scheme, Temperature dependency characteristics of BJT and MOSFET in Saturation region is investigated . In the schematic shown in figure 2, the first circuit gives the voltage that is proportional to absolute temperature and this voltage is given as the input to the pmos of the differential amplifier in order to get the required amplification range. In the final stage of the circuit, comparator is designed by giving the differential amplifier output as the input to the first input of the comparator and pulse is given to the 2nd input so that necessary digitized temperature information is obtained. The drain current of an NMOS transistor in the saturation region is given by

$$I_D = 1/2 \mu_n C_{OX} W/L (V_{GS} - V_{TH}) \dots \dots (7)$$

Where,

W/L is the aspect ratio of the transistor.

μ is the carrier mobility .

C_{OX} is the gate-oxide capacitance .

V_{TH} is the threshold voltage of a MOSFET.

In the above equation threshold voltage and mobility are the main temperature dependent parameters. As the temperature increases, both the threshold voltage and the mobility decrease. But the decrease of V_{TH} and mobility have opposing effects on the drain current; a lower threshold voltage tends to increase

the drain current, but a lower mobility tends to decrease it.

B. Temperature dependency characteristics of only MOSFET in Sub threshold region

Sub threshold region operates with the gate to source voltage less than the transistors threshold voltage V_T . This is done to ensure that all the transistors are indeed operating in the sub threshold region[1]

The sub-threshold drain current I_D of a MOSFET is an exponential function of the gate-source voltage V_{GS} , and given by

Where,

$$I_D = KI_0 e^{(V_{GS} - V_{TH}) / \eta V_T} \dots \quad (8)$$

$$I_0 = \mu C (\eta - 1) \times V_T^2$$

K is the aspect ratio ($=W/L$) of the transistor

μ is the carrier mobility

C_{OX} is the gate-oxide capacitance .

V_T is the thermal voltage .

V_{TH} is the threshold voltage of a MOSFET .

η is the sub-threshold slope factor.

III. BLOCK DIAGRAM OF THE PROPOSED TEMPERATURE SENSOR

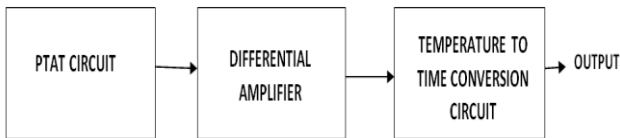


Figure 2. Block Diagram of the Proposed Temperature Sensor

This block diagram depicts the concept of whole operation where in the PTAT circuit block, the obtained voltage is given as an input to differential amplifier to obtain the amplified version and good linear range of the PTAT voltage versus temperature. In temperature to time conversion circuit, the obtained temperature information is converted into time.

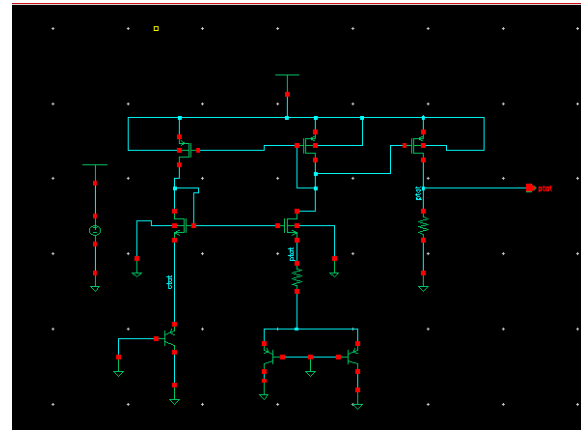


Fig3.Schematic of the PTAT circuit in saturation region.

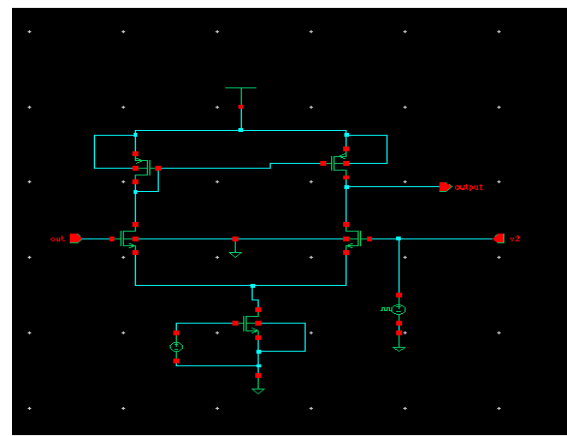


Fig4.Schematic of the Temperature to Time conversion circuit in saturation region.

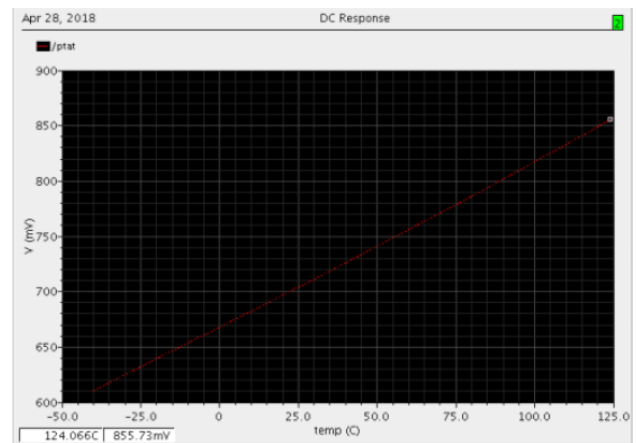


Figure 5. DC response of the proposed ptat circuit showing the linear relationship of voltage and temperature.

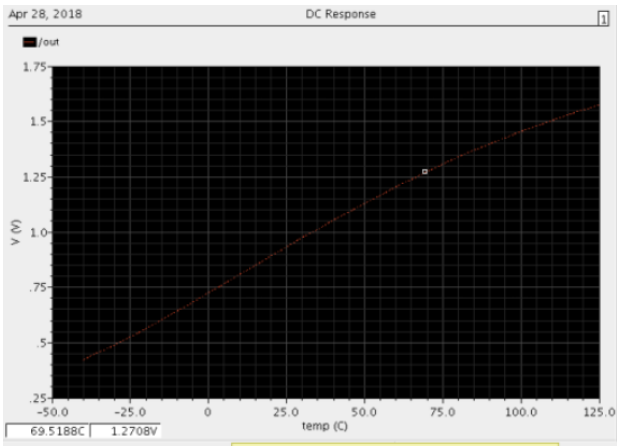


Figure 6. DC response of the proposed differential amplifier circuit showing the linear relationship of voltage and temperature.

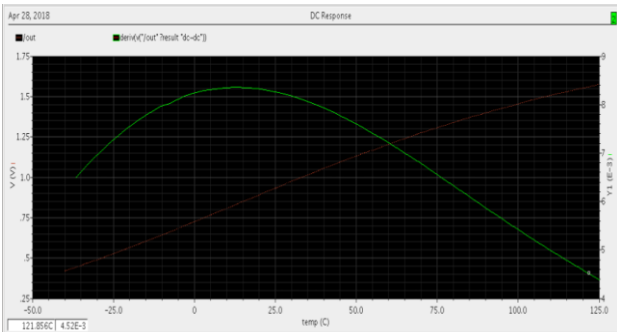


Figure 7. DC response showing the slope of the proposed ptat circuit.

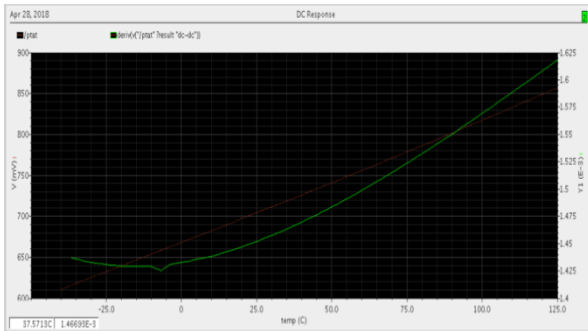


Figure 8. DC response showing the slope of the differential amplifier circuit.

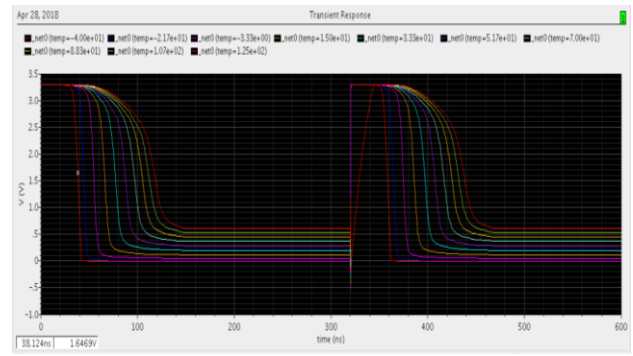


Figure 9. Transient response of varying pulse width for different temperature values.

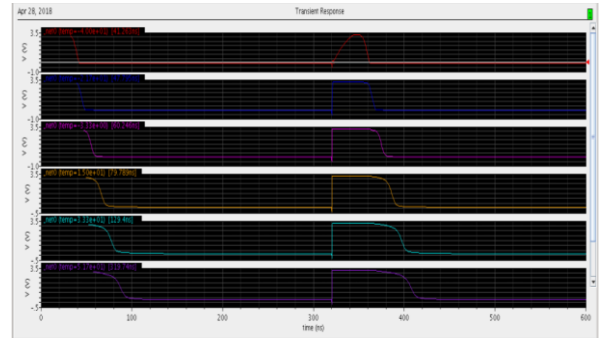


Figure 10. Expanded version of Transient response of varying pulse width for different temperature values.

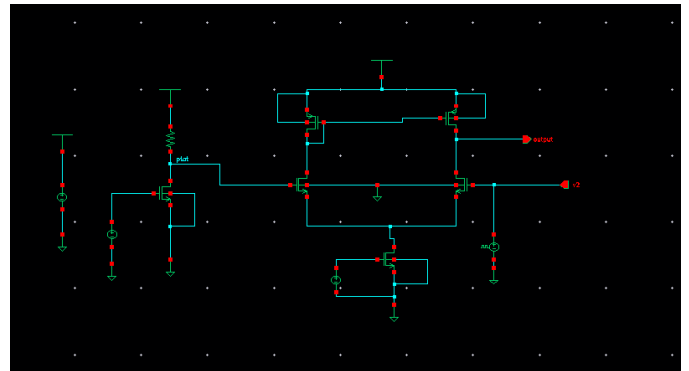


Figure 11. Schematic of the proposed temperature sensor in subthreshold region.

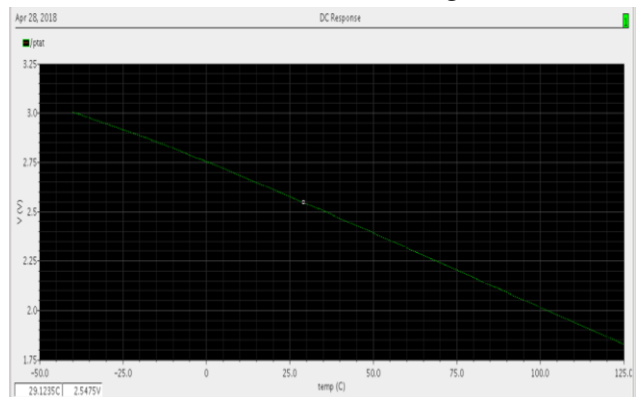


Figure 12. DC Response of the proposed temperature sensor in sub-threshold region showing the linear relationship of voltage and temperature.

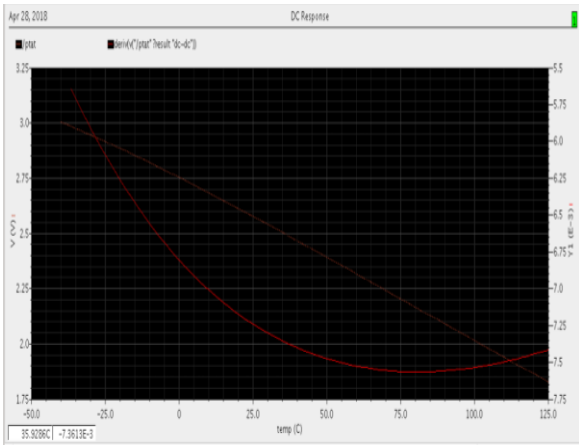


Figure 13. DC response showing the slope of the proposed temperature sensor.

Figure 14. Transient response of varying pulse width for different temperature values

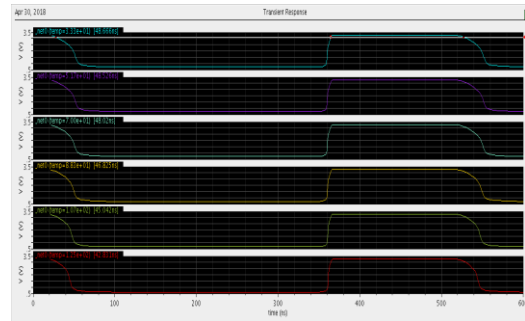
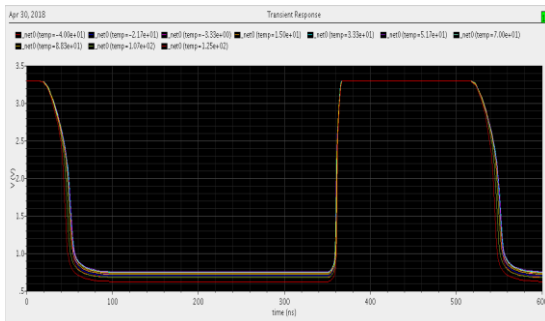


Figure 15. Expanded version of Transient response of varying pulse width for different temperature values.



IV. COMPARISON TABLE OF TEMPERATURE DEPENDENCY CHARACTERISTICS IN SATURATION AND SUBTHRESHOLD REGION

PARAMETER	Proposed PTAT circuit in saturation region	Differential amplifier circuit	Proposed PTAT circuit in sub-threshold region
Voltage Range	(857.24mV-611.93mV)=245.31mV	(1.5745-423.61mV)=1.15V	(3.005V-1.832V)=1.173V
Temperature Range	-40°C to +125°C	- 40°C to +125°C	- 40°C to +125°C

V. COMPARISON TABLE OF SLOPE VERSUS TEMPERATURE RANGE IN SATURATION AND SUBTHRESHOLD REGION

PARAMETER	TEMPERATURE RANGE	SLOPE in E-3
Proposed PTAT circuit in saturation region	-36°C to +60 °C	1.432 to 1.499
	65 °C to 115 °C	1.5 to 1.599
	116 °C to 125 °C	1.618
Differential amplifier circuit	-36 °C to -29 °C	6.55 to 6.99

	-28°C to -10°C	7.07 to 7.96
	-9°C to 61°C	8 to 8.24
	62°C to 64°C	7.1 to 7.02
	65°C to 87°C	7 to 6.01
	88°C to 109°C	5.9 to 5.01
	110°C to 125°C	4.96 to 4.4
Proposed PTAT circuit in sub-threshold region	-36°C to +27°C	-5.65 to -5.99
	-28°C to 9°C	-6 to -6.99
	10°C to 125°C	-7.012 to -7.414

VI. CONCLUSION

This paper proposes a design of temperature sensor by utilizing the temperature dependency characteristics of BJT and MOSFET. The voltage or current across MOSFETs and BJT always varies with the temperature, but the challenge in this project is to design these types of sensors to linearize this variation. In this proposed work, the required linearity is achieved within the sensing range. In the next level, Amplification circuit is designed to increase the voltage range which results in achieving more linearity. After achieving the linearity, readout circuit is designed to digitize the obtained temperature information. The proposed temperature sensor is simulated in Cadence Analog Design Environment with GPDK180nm library.

VII. REFERENCES

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